

General Description

The MAX3892 serializer is ideal for converting 4-bitwide, 622Mbps parallel data to 2.5Gbps serial data in DWDM and SONET/SDH applications. A 4 × 4-bit FIFO allows for any static delay between the parallel output clock and parallel input clock. Delay variation up to a unit interval (UI) is allowed after reset. A fully integrated phase-locked loop (PLL) synthesizes an internal 2.5GHz serial clock from a 622MHz, 155.5MHz, 77.8MHz, or 38.9MHz reference clock. A selectable dual VCO allows excellent jitter performance at both SONET and forward-error correction (FEC) data rates.

Operating from a single 3.3V supply, this device accepts low-voltage differential-signal (LVDS) clock and data inputs for interfacing with high-speed digital circuitry, and delivers current-mode logic (CML) serial data and clock outputs. A loopback data output is provided to facilitate system diagnostic testing. The MAX3892 is available in the extended temperature range (-40°C to +85°C) in a 44-pin QFN package.

Applications

SONET/SDH OC-48 Transmission Systems **WDM Transponders** Add/Drop Multiplexers Dense Digital Cross-Connects Backplane Interconnects

Features

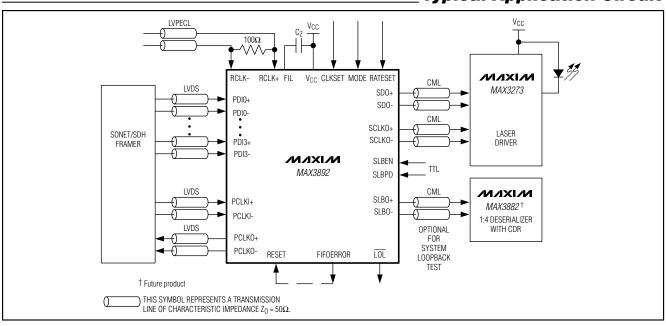
- ♦ Single +3.3V Supply
- **♦ 455mW Power Consumption**
- ♦ 1.4pspms Maximum Jitter Generation
- ♦ 4 × 4-Bit FIFO Input Buffer
- ♦ 622Mbps/666Mbps Parallel to 2.5Gbps/2.7Gbps **Serial Conversion**
- ♦ 622MHz/667MHz or 311MHz/333MHz Clock Input
- ♦ On-Chip Clock Synthesizer
- **♦ Multiple Clock Reference Frequencies:** (622.08MHz, 155.52MHz, 77.76MHz, 38.88MHz) or (666.51MHz, 166.63MHz, 83.31MHz, 41.66MHz)
- ♦ LVDS Parallel Clock and Data Inputs
- **♦ CML Serial Data and Clock Outputs**
- **♦ Additional CML Output for System Loopback Testina**

Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE
MAX3892EGH	-40°C to +85°C	44 QFN-EP*

^{*}EP = exposed pad

Typical Application Circuit



MIXIM

Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

Supply Voltage VCC, VCCO, VCCVCO	0.5V to +5V
All Inputs and FIL	0.5V to (V _{CC} + 0.5V)
LVDS Output Voltage (PCLKO±)	0.5V to $(V_{CC} + 0.5V)$
CML Output Current (SDO±, SCLKO±	, SLBO±)22mA
Continuous Power Dissipation ($T_A = +8$	85°C)
44-Pin QFN (derate 25mW/°C above	+85°C)1625mW

Operating Temperature Range	40°C to +85°C
Storage Temperature Range	55°C to +150°C
Lead Temperature (soldering, 10s).	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +3.0 \text{V to } +3.6 \text{V}, T_A = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}. \text{ Typical values are at } V_{CC} = +3.3 \text{V}, \text{ differential LVDS load} = 100 \Omega \pm 1 ^{\circ}\text{K}, T_A = +25 ^{\circ}\text{C}, \text{ unless otherwise noted.})$ (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS		
Supply Current	Icc	(Note 2)		138	190	mA		
LVDS INPUT SPECIFICATIONS (PDI[30]±, PCLKI±)								
Input Voltage Range	VI		0		2400	mV		
Differential Input Voltage	IV _{ID} I		100			mV		
Input Common-Mode Current		LVDS input V _{OS} = 1.2V		61		μΑ		
Threshold Hysteresis				45		mV		
Differential Input Resistance	R _{IN}		83	100	117	Ω		
LVPECL INPUT SPECIFICATIONS	(RCLK±)							
Input High Voltage	VIH		V _{CC} - 1.16		V _{CC} - 0.88	٧		
Input Low Voltage	VIL		V _{CC} - 1.81		V _{CC} - 1.48	V		
Input Bias Voltage				V _{CC} - 1.3		V		
Single-Ended Input Resistance				>1.0		kΩ		
Differential Input Voltage Swing			300		1900	mVp-p		
LVDS OUTPUT SPECIFICATIONS	(PCLKO±)							
Output High Voltage	VoH				1.475	V		
Output Low Voltage	V _{OL}		0.925			V		
Differential Output Voltage	IV _{OD} I		250		400	mV		
Change in Magnitude of Differential Output Voltage for Complementary States	ΔIV _{OD} I				25	mV		
Offset Output Voltage			1.125		1.275	V		
Change in Magnitude of Output Offset Voltage for Complementary States	ΔIV _{OS} I				25	mV		

DC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC}=+3.0 \text{V to } +3.6 \text{V}, T_A=-40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}.$ Typical values are at $V_{CC}=+3.3 \text{V},$ differential LVDS load = $100 \Omega \pm 1 \%,$ $T_A=+25 ^{\circ}\text{C},$ unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Differential Output Resistance			80		140	Ω	
Output Current		Shorted together			12	mA	
Output Current		Shorted to ground			40	mA	
CML OUTPUT SPECIFICATIONS	(SDO±, SCL	KO±, SLBO±)					
Differential Output		$R_L = 100\Omega$ differential	640	800	1000	mVp-p	
Differential Output Resistance			83	100	117	Ω	
Output Common-Mode Voltage		$R_L = 50\Omega$ to V_{CC}		V _{CC} - 0.2		V	
LVTTL SPECIFICATIONS (RESET	, RATESET,	SLBEN, SLBPD FIFOERROR, LOL)					
Input High Voltage	VIH		2.0			V	
Input Low Voltage	VIL				0.8	V	
Input High Current	lін		-30		+10	μΑ	
Input Low Current	Ι <u>Ι</u> L		-50		+10	μΑ	
Output High Voltage	VoH	I _{OH} = 20μA	2.4		V _C C	V	
Output Low Voltage	V _{OL}	$I_{OL} = 1mA$			0.4	V	
PROGRAMMING INPUTS (CLKSET, MODE)							
Input Current		Input = 0 or V _{CC}	-500		+500	μΑ	

AC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +3.0 \text{V to } +3.6 \text{V}, T_A = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}. \text{ Typical values are at } V_{CC} = +3.3 \text{V}, \text{ differential LVDS loads} = 100 \Omega \pm 1 ^{\circ}\text{C}, \text{ CML loads} = 50 \Omega \pm 1 ^{\circ}\text{C}, \text{ to } +25 ^{\circ}\text{C}, \text{ unless otherwise noted.})$ (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS			
PARALLEL INPUT SPECIFICATION	PARALLEL INPUT SPECIFICATIONS (PDI±, PCLKI±)								
Derellel Input Dete Dete		RATESET = GND		622	Mbpa				
Parallel Input Data Rate		RATESET = V _{CC}		666		Mbps			
Derellel Input Cleak Dete		MODE = OPEN or V _{CC}		622		MHz			
Parallel Input Clock Rate		MODE = SHORT or $30k\Omega$ to GND		311		IVIDZ			
Parallel Input Setup Time	tsu	(Note 4)	-94			ps			
Parallel Input Hold Time	tH	(Note 4)	300			ps			
PARALLEL CLOCK OUTPUT SPE	CIFICATIO	NS (PCLKO±)							
Parallel Clock Output Rise/Fall Time	t _r , t _f	20% to 80%	100		200	ps			
Parallel Clock Output Duty Cycle			46		54	%			
SERIAL OUTPUT SPECIFICATION	SERIAL OUTPUT SPECIFICATIONS (SDO±, SCLKO±)								
Social Output Data Bata		RATESET = GND		2.488		Oleve			
Serial Output Data Rate		RATESET = V _{CC}		2.666		Gbps			
Serial Data Output Rise/Fall Time	t _r , t _f	20% to 80%			80	ps			
Serial Output Clock to Data Delay	t _{CLK-Q}	(Note 5)	-25		25	ps			

AC ELECTRICAL CHARACTERISTICS (continued)

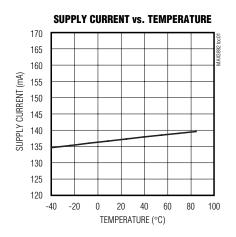
 $(V_{CC} = +3.0 \text{V to } +3.6 \text{V}, T_A = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$. Typical values are at $V_{CC} = +3.3 \text{V}$, differential LVDS loads = $100\Omega \pm 1 ^{\circ}$, CML loads = $50\Omega \pm 1 ^{\circ}$, $T_A = +25 ^{\circ}\text{C}$, unless otherwise noted.) (Note 3)

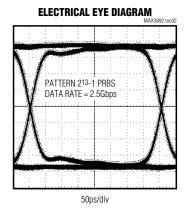
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Serial Clock Output Jitter Generation	JG	(Note 6)		1.2	1.4	psRMS	
Serial Data Output Random Jitter	RJ				1.4	psRMS	
Serial Data Output Deterministic Jitter	DJ	(Note 7)			19	ps _{p-p}	
REFERENCE CLOCK INPUT SPE	CIFICATION	IS (RCLK)					
Reference Clock Frequency Tolerance			±100			ppm	
Reference Clock Input Duty Cycle			30		70	%	
RESET INPUTS (RESET)	RESET INPUTS (RESET)						
Minimum Pulse Width of FIFO Reset		UI is PCLKO period		4		UI	
Tolerated Drift Between PCLKI and PCLKO After Reset		UI is PCLKO period		±1		UI	

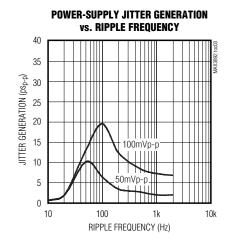
- Note 1: Specifications at -40°C are guaranteed by design and characterization.
- Note 2: Measured with SLBO/CLK622 and SCLK outputs disabled and CML outputs open.
- Note 3: AC characteristics are guaranteed by design and characterization.
- Note 4: In 622MHz clock mode, the parallel data is clocked in by the rising edge of the 622MHz/666MHz parallel clock input. In the 311MHz clock mode, the parallel data is clocked in on both the rising and falling edges of the clock. The parallel input setup and hold time increases by 60ps if the duty cycle is between 48% to 52% in 311MHz mode (Figure 1).
- Note 5: Relative to the falling edge of the SCLKO.
- **Note 6:** Measurement bandwidth is BW = 12kHz to 20MHz.
- **Note 7:** Deterministic jitter includes pattern-dependent jitter and pulse-width distortion. Measured using a 2⁷ 1 PRBS pattern with 96 consecutive identical digits.

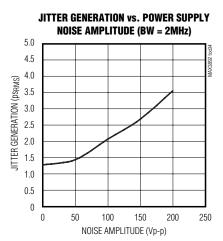
Typical Operating Characteristics

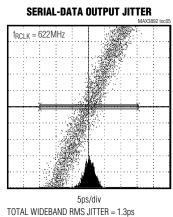
(V_{CC} = ± 3.3 V, CML loads AC-coupled to $50\Omega \pm 1\%$, T_A = ± 25 °C, unless otherwise noted.)











TOTAL WIDEBAND RMS JITTER = 1.3ps PEAK-TO-PEAK JITTER = 15.8ps

Pin Description

PIN	NAME	FUNCTION
1, 16, 22, 27, 33, 44	GND	Supply Ground
2, 5, 8, 11	VCCO	Supply Voltage for Outputs +3.3V. Add bypass capacitors near these pins before connecting to the V _{CC} power plane.
3	SCLKO-	Negative Serial Clock Output, CML 2.488GHz or 2.666GHz
4	SCLKO+	Positive Serial Clock Output, CML 2.488GHz or 2.666GHz
6	SDO-	Negative Serial Data Output, CML 2.488Gbps or 2.666Gbps
7	SDO+	Positive Serial Data Output, CML 2.488Gbps or 2.666Gbps

Pin Description (continued)

	NAME	I in Bescription (continued)
PIN	NAME	FUNCTION
9	SLBO-	Negative System Loop-Back Output or 622MHz/666MHz Clock Output. Select CML data or clock as shown in Table 1.
10	SLBO+	Positive System Loop-Back Output or 622MHz/666MHz Clock Output. Select CML data or clock as shown in Table 1.
12	SLBPD	System Loopback Power Down, TTL Input. SLPD = high activates the system loopback output driver; SLBPD = low powers down the loop-back output driver
13	SLBEN	System Loop-Back Enable Input, TTL Input. SLBEN = high activates the system loop-back output; SLBEN = low activates the 622MHz/666MHz reference clock output.
14	RESET	FIFO Reset, TTL Input. An active-high reset recenters the FIFO to tolerate maximum skew between PCLKI and PCLKO.
15	FIFOERROR	FIFO Error Indicator, TTL Output. Active high when the read/write clocks access the same FIFO address. This signal may be used to control RESET.
17, 28, 36, 41	Vcc	Supply Voltage, +3.3V
18	TOL	Loss of Lock, TTL Output. An active low indicates that the VCO and reference frequency differ by 500ppm.
19	MODE	Clock Control Input: $ \begin{aligned} &\text{MODE} = \text{GND}; \ f_{\text{PCLKI}} = 311.04 \text{MHz}/333 \text{MHz with SCLKO active} \\ &\text{MODE} = 30 \text{k} \Omega \text{ to GND}; \ f_{\text{PCLKI}} = 311.04 \text{MHz}/333 \text{MHz with SCLKO off} \\ &\text{MODE} = \text{OPEN (float)}; \ f_{\text{PCLKI}} = 622.08 \text{MHz}/666 \text{MHz with SCLKO off} \\ &\text{MODE} = \text{VCC}; \ f_{\text{PCLKI}} = 622.08 \text{MHz}/666 \text{MHz with SCLKO active} \end{aligned} $
20	PCLKI+	Positive Parallel Clock, LVDS Input. Data is written to the input register on the clock rising edge in 622Mbps mode and on both rising and falling edges in 311Mbps mode (Figure 1).
21	PCLKI-	Negative Parallel Clock, LVDS Input (Figure 1).
23, 25, 29, 31	PDI3+ to PDI0+	Positive Data Inputs, LVDS (622Mbps or 666Mbps)
24, 26, 30, 32	PDI3- to PDI0-	Negative Data Inputs, LVDS (622Mbps or 666Mbps)
34	PCLKO+	Positive Parallel Clock Output, LVDS. This clock may be 622.08MHz or 666MHz.
35	PCLKO-	Negative Parallel Clock Output, LVDS. This clock may be 622.08MHz or 666MHz.
37	RCLK+	Positive Reference Clock Input, LVPECL
38	RCLK-	Negative Reference Clock Input, LVPECL
39	CLKSET	Reference Clock Rate Programming Pin: CLKSET = V_{CC} ; RCLK = 622.08MHz/666MHz CLKSET = OPEN (float); RCLK = 155.52MHz/167MHz CLKSET = 30 k Ω to GND; RCLK = 77.76 MHz/83.3MHz CLKSET = GND; RCLK = 38.88 MHz/41.6MHz
40	RATESET	Data Rate Select, TTL Input. RATESET = high for 2.666Gbps, RATESET = low for 2.488Gbps.
42	FIL	PLL Capacitor Pin. Connect a 0.1µF capacitor from this pin to VCCVCO.
43	VCCVCO	Supply Voltage for VCO \pm 3.3V. Add bypass capacitors near this pin before connecting to the V _{CC} power plane.
EP	Exposed Paddle	The exposed paddle must be soldered to ground for proper thermal and electrical operation.

Detailed Description

The MAX3892 converts 4-bit-wide, 622Mbps/667Mbps data to 2.5Gbps/2.7Gbps serial data (Figure 2). Data is loaded into the 4:1 MUX through a 4 × 4-bit FIFO buffer for wide tolerance to clock skew. Clock and data inputs are LVDS levels while high-speed serial outputs are CML. An internal PLL frequency synthesizer generates a serial clock from a low-speed reference clock.

Low-Voltage Differential-Signal Inputs and Outputs

The MAX3892 has LVDS inputs and outputs for interfacing with high-speed digital circuitry. The LVDS standard is based on the IEEE 1596.3 LVDS specification. This technology uses differential low-voltage swings to achieve fast transition times, minimized power dissipation, and noise immunity. For proper operation, the parallel clock LVDS outputs (PCLKO+, PCLKO-) require 100Ω differential DC termination between the positive and negative outputs. Do not terminate these outputs to ground. The parallel data and parallel clock LVDS inputs (PDI+, PDI-, PCLKI+, PCLKI-) are internally terminated with 100Ω differential input resistance, and therefore do not require external termination.

PECL Inputs

The reference clock (RCLK+, RCLK-) has PECL inputs for interfacing to a crystal oscillator with AC or DC connections. The RCLK inputs are self-biasing to $V_{\rm CC}$ -1.3V for AC-coupled inputs. Only a 100Ω differential termination resistance must be added when inputs are AC-coupled.

Current-Mode Logic Outputs

The 2.5Gbps/2.7Gbps data, clock, and system loop-back outputs (SDO+, SDO-, SCLKO+, SCLKO-, SLBO+, SLBO-) of the MAX3892 are designed using current-mode logic (CML). The configuration of the MAX3892 CML output circuit includes internal 50Ω back termination to VCC (Figure 3). These outputs are intended to drive a 50Ω transmission line terminated with a matched load impedance.

FIFO Buffer

Data is latched into the MAX3892 by the parallel input clock PCLKI. The parallel input clock serves as the FIFO write clock. The parallel output clock PCLKO acts as the FIFO read clock that loads the 4:1 MUX. The FIFO allows the read and write clocks to vary by up to ± 10 II. Conditions that result in the read and write clock accessing the same FIFO address are indicated by

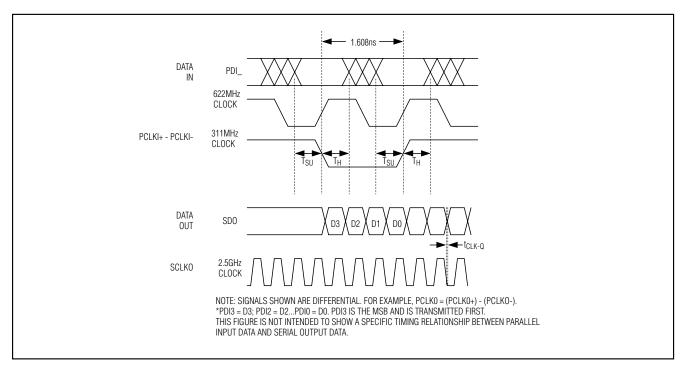


Figure 1. Timing Diagram



Table 1. Loop-Back Operation Mode

SLBPD	SLBEN	SLBO± OUTPUT
V _I L	Χ	Power-Down SLBO Output
VIH	VIL	622MHz/667MHz Clock Output
V _{IH}	V _{IH}	2.5Gbps/2.7Gbps System Loop-Back Output

Table 2. Setting the Reference Clock Frequency

CLKSET	RATESET	RCLK± FREQUENCY (MHz)
Voc	Vcc	666
V _C C	GND	622
OPEN	Vcc	166.5
OPEN	GND	155.52
30kΩ to GND	V _C C	83.25
30K22 10 GND	GND	77.76
GND	Vcc	41.63
GND	GND	38.88

latching high FIFOERROR. To clear this condition, RESET must be asserted high for at least 4UI. FIFOER-ROR may be tied directly to the RESET input to recenter the FIFO. After reset, the full elastic range of the FIFO is available again.

Frequency Synthesizer

The PLL synthesizes a 2.5Gbps/2.7Gbps clock (SCLKO) from an external reference clock. The PLL reference clock (RCLK) may be 622.08MHz/666.53MHz, 155.52MHz/166.6MHz, 77.76MHz/83.3MHz or 38.88MHz/41.65MHz as determined by CLKSET and RATESET. See Table 2 for the reference frequency selection. The parallel output clock PCLKO is also derived from the synthesizer to be SCLKO divided by 4. A TTL-compatible loss-of-lock indicator, LOL, goes low when the VCO is unable to lock to the reference frequency. Frequency difference on RCLK with respect to the divided down SCLKO greater than 500ppm is indicated by a low state on LOL. When the frequency difference between the clocks is less than 250ppm, LOL high indicates a lock condition.

System Loopback

The MAX3892 is designed to allow system loop-back testing. The loop-back outputs (SLBO+, SLBO-) of the MAX3892 may be directly connected to the loop-back inputs of a deserializer (such as the MAX3882) for system diagnostics. Alternatively, the SLBO pins can be programmed to provide a 622MHz reference clock.

Table 3. Setting the Clock Mode

MODE	RATESET	PCLKI± FREQUENCY (MHz)	SCLKO± FREQUENCY (GHz)
Vac	Vcc	666Hz	2.666
Vcc	GND	622Hz	2.488
OPEN	Vcc	666Hz	Disabled
OPEN	GND	622Hz	Disabled
30kΩ to	Vcc	333Hz	Disabled
GND	GND	311Hz	Disabled
GND	Vcc	333Hz	2.666
GIND	GND	311Hz	2.488

This reference clock can provide a clock hold-over signal to a clock and data recovery (CDR) circuit in the event of loss of signal (LOS).

_Design Procedure

Clock Mode Selection

The frequencies of the MAX3892 can be set up using CLKSET, RATESET, and MODE as shown in Tables 2 and 3.

Layout Techniques

For best performance, use good high-frequency layout techniques. Filter voltage supplies and keep ground connections short. Use multiple vias where possible. Also, use controlled-impedance transmission lines to interface with the MAX3892 clock and data inputs and outputs.

Exposed-Pad Package

The EP 44-pin QFN incorporates features that provide a very low thermal-resistance path for heat removal from the IC to a PC board. The MAX3892's EP must be soldered directly to a ground plane with good thermal conductance.

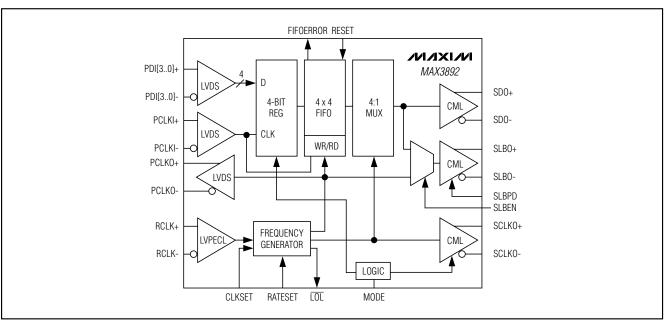


Figure 2. Functional Diagram

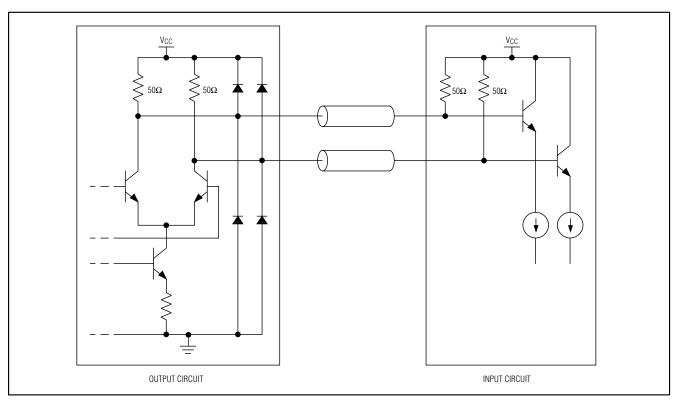


Figure 3. Current-Mode Logic

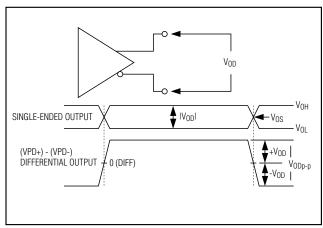


Figure 4. Differential Output Levels

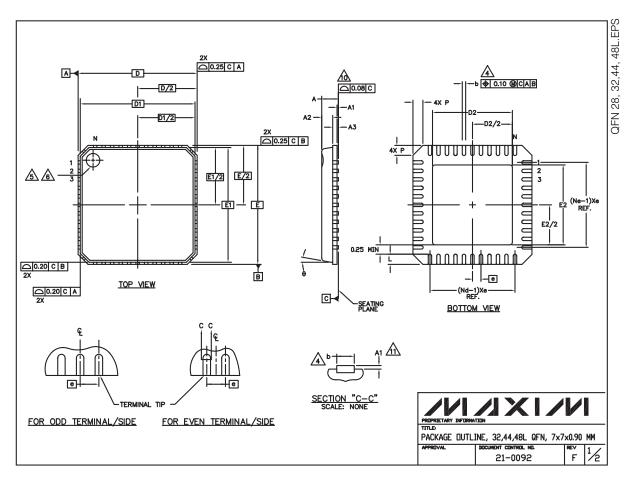
Pin Configuration

Chip Information

GND VCCVCO FIL VCC RATESET CLKSET RCLK-RCLK-V_{CC} PCLKO-PCLKO+ TOP VIEW ${\sf GND}$ 33 GND 32 PDI0-VCCO SCLKO-31 PDI0+ SCLK0+ 30 PDI1-VCCO PDI1+ MIXIM 29 SDO-28 V_{CC} 6 MAX3892 SDO+ GND VCCO 8 PDI2-SLBO-PDI2+ 9 SLBO+ PDI3-10 24 VCCO PDI3+ **QFN** *THE EXPOSED PADDLE MUST BE SOLDERED TO SUPPLY GROUND ON THE CIRCUIT BOARD.

TRANSISTOR COUNT: 6210

Package Information



Package Information (continued)

- 1. DIE THICKNESS ALLOWABLE IS 0.305mm MAXIMUM(.012 INCHES MAXIMUM)
- 2. DIMENSIONING & TOLERANCES CONFORM TO ASME Y14.5M. 1994.

 3. N IS THE NUMBER OF TERMINALS.

 Nd IS THE NUMBER OF TERMINALS IN X—DIRECTION &

 Ne IS THE NUMBER OF TERMINALS IN Y—DIRECTION.

- ANDIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.20 AND 0.25mm FROM TERMINAL TIP.
- 5 THE PIN #1 IDENTIFIER MUST EXIST ON THE TOP SURFACE OF THE PACKAGE BY USING INDENTATION MARK OR INK/ LASER MARKED. OF PACKAGE BODY.
- 6 EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.
- 7. ALL DIMENSIONS ARE IN MILLIMETERS.
- 8. PACKAGE WARPAGE MAX 0.08mm.
- APPLIED FOR EXPOSED PAD AND TERMINALS. EXCLUDE EMBEDDED PART OF EXPOSED PAD FROM MEASURING.
- 10. MEETS JEDEC MO220.
- 11. THIS PACKAGE OUTLINE APPLIES TO ANVIL SINGULATION (STEPPED SIDES) AND TO SAW SINGULATION (STRAIGHT SIDES) QFN STYLES.

S _Y	COMMON								
-0 WE 4	DIMENSIONS								
٩	MIN.	NOM.	MAX.	Tε					
Α	0.80	0.90	1.00						
A1	0.00	0.01	0.05						
A2	0.00	0.65	1.00						
A3	0.20 REF.								
D	7.00 BSC								
D1	6.75 BSC								
Ε	7.00 BSC								
E1	6.75 BSC								
Φ	0.		12°						
Р	0		0.60						
D2	2.25	_	5.25						
E2	2.25	_	5.25						

SYMBO	PITCH	NON		No _T	SMEAS	PITCH			N _O T	BET	PITCH	11011	1111	No.
e	MIN.	0.65 BSC	MAX.	, E	e	MIN.	0.50 BSC	MAX.		e	MIN.	0.50 BSC	MAX.	3,
N		32		3	N		44		3	N		48		3
Nd		8		3	Nd		11		3	Nd		12		3
Ne		8		3	Ne		11		3	Ne		12		3
	0.35	0.55	0.75		L	0.35	0.55	0.75		П	0.30	0.40	0.50	
Ъ	0.23	0.28	0.35	4	ь	0.18	0.23	0.30	4	ь	0.18	0.23	0.30	4



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